

STRUCTURAL EVOLUTION OF SPUTTERED INDIUM OXIDE THIN FILMS

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The indium oxide thin films were deposited at room temperature by reactive magnetron sputtering in the mixture of oxygen and argon on silicon and oxidized silicon substrates. The influence of the oxygen flow in the reactive mixture and post-deposition annealing on the structural properties were investigated. The as deposited In_2O_3 films showed a dominating randomly oriented nanocrystalline structure of cubic In_2O_3 . The grain size decreased with increasing oxygen concentration in the plasma. Annealing in reducing atmospheres (vacuum, nitrogen and argon), besides improving the crystallinity, led to a partial cubic to rhombohedral phase transition in the indium oxide films.

Key words: In_2O_3 thin films, dc magnetron sputtering, structure, cubic indium oxide, rhombohedral indium oxide

1 INTRODUCTION

Indium oxide belong among transparent conducting oxides are widely used in various applications thanks to their low resistivity, high optical transparency and wide band gap. These applications include using in solar applications, the transparent electrodes in various optoelectronic devices, the barrier layers in tunnel junctions, the active layers of gas sensors or the material for ultraviolet lasers [1]. Therefore, there have been a lot of works on investigations of their growth conditions and studying their properties in dependence on the synthesis methods ranging from such as evaporation, sputtering, sol-gel process and chemical pyrolysis to metal organic chemical vapour deposition [2–4].

In_2O_3 thin films have a good adherence to the substrate surface and high chemical inertness [5]. In general, undoped binary oxide films are insulators in their stoichiometric form. On the other hand, this property can be changed by suitable doping and controlling the concentration of oxygen vacancies. In_2O_3 can appear in two stable modifications as body-centered (bcc) cubic ($a = 10.118 \text{ \AA}$) and rhombohedral (rh) ($a = 5.478 \text{ \AA}$ and $c = 14.51 \text{ \AA}$) (crystallographic data are taken from [6]). They can be stabilized by choosing appropriate deposition conditions or synthesis methods [7, 8]. The rhombohedral phase has been rarely produced and it exhibits better physical properties than the cubic one. The difference seems to be the results packing of the anion layers in the rhombohedral In_2O_3 [9].

In this study, XRD, HRTEM and SAED were used for study of the structural evolution of indium oxide films. It

was found that annealing of cubic phase will cause, besides recrystallization of the film, partial phase transition from the cubic into the rhombohedral phase.

2 EXPERIMENTAL DETAILS

The In_2O_3 films were deposited by dc reactive magnetron sputtering from an In target (4" in diameter, 99.99% pure) in a mixture of oxygen and argon onto unheated Si and oxidized Si substrates. A sputtering power of 75 W was used. Both argon inert flow and oxygen reactive flow were controlled by mass flow controllers. The flow of oxygen in the reactive mixture $\text{O}_2\text{-Ar}$ was changed in the range of 40–80 sccm. The relative partial pressure of oxygen, defined as $p(\text{O}_2)/p(\text{O}_2+\text{Ar})$, varied from 10 to 30%. The total gas pressure was kept constant at 0.8 Pa and adjusted by a piezoceramic valve. Some of the deposited films were post-growth annealed in a tube furnace for 1 hour at 400 and 500 °C in N_2 and Ar atmospheres as well as in vacuum.

The crystal structure was identified with a Theta-Theta X-ray diffractometer (XRD) D 5000 with a Goebel mirror in grazing incidence geometry with $\text{CuK}\alpha$ radiation. Further structural features of the films were investigated by means of a Tecnai 20 S-TWIN transmission electron microscope (TEM) operated at 200 kV. It is equipped with energy dispersive X-ray (EDX) facility for high resolution chemical analysis. Selected electron diffraction (SAED) patterns have been recorded together with bright and dark field images of the film structure.

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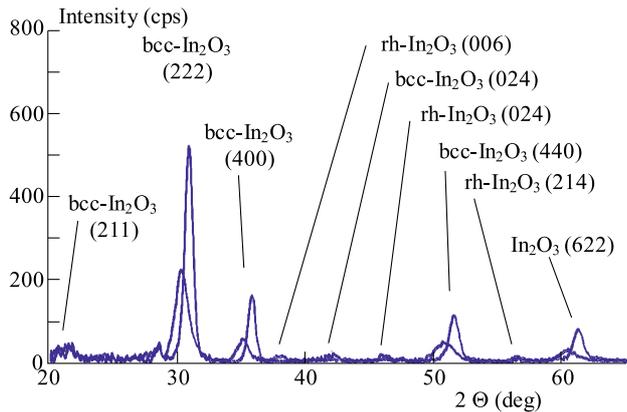


Fig. 1. XRD diffraction patterns of In_2O_3 films: as-deposited at a relative oxygen partial pressure of 20% and annealed at 500 °C in nitrogen, (black line represents as-deposited sample, grey line represents annealed samples)

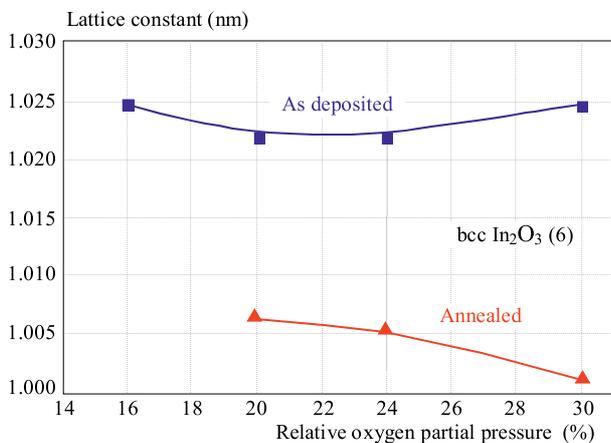


Fig. 2. Lattice constants of the (bcc) indium oxide fraction in the film in dependence on the relative oxygen partial pressure in the working gas for as deposited and annealed at 500 °C samples. The horizontal line indicates the lattice constant of unstrained bcc In_2O_3

3 RESULTS AND DISCUSSION

The typical XRD diffractograms taken from the indium oxide layer after deposition and annealed at 500 °C for 1 h in nitrogen are shown in Fig. 1. The XRD patterns revealed a clear polycrystalline structure. The diffraction patterns consist of diffraction peaks related to the (bcc) structure of In_2O_3 and corresponding to (211), (222), (400), (440) and (622) lattice planes correlating with the results obtained in [5]. The strongest diffraction peak is the peak related to the (222) lattice plane indicating corresponding preferential orientation along this direction. After annealing all diffraction peaks were shifted towards higher 2θ angles by 0.5° – 0.9° , as depicted in Fig. 1. This implies that the process of post-deposition annealing at 500 °C has shrunk the lattice constant or caused a change in the residual strain between the lattice planes, resulting in a decrease of the lattice parameter. The obtained lattice plane values extracted from the diffraction

peaks before and after annealing are given in Fig. 2. In the as deposited case the lattice constants are increased as compared with the unstrained value of the lattice parameter for (bcc) In_2O_3 which is 1.0118 nm [6]. The experimentally obtained lattice parameters are in the range between 1.021 and 1.026 nm for as-deposited samples. After annealing the lattice parameter drops below the theoretical value and is within the range of 1.001 and 1.006 nm. Such drastic changes are a common effect in sputtered oxide films [5] and can be attributed to out-diffusion of the implanted sputter gases, defect annealing and defect-defect interaction.

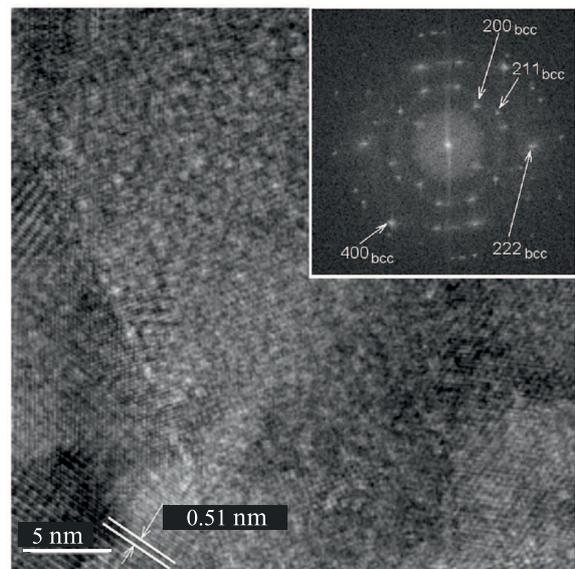


Fig. 3. HRTEM image of In_2O_3 as-deposited film at a relative oxygen partial pressure of 15%. The inset shows the FFT image of the thin film

Further reasons for the change in the lattice constants can be oxygen vacancy formation and differences in the thermal expansion coefficients between the substrate and the thin film. The intensities of the diffraction peaks were also significantly higher (at least two times in comparison with as-deposited) for all annealed samples. Moreover, the values of the full-width at half-maximum (FWHM) of the annealed samples were smaller, indicating better crystallinity of the indium oxide film due to the carried out annealing procedure. Additionally, if the relative oxygen partial pressure was equal to or exceeds 15% another remarkable change was observed. Namely, the appearance of weak additional diffraction peaks in the diffraction pattern of the annealed sample. The peak positions correspond to the (006), (024) and (214) lattice planes of the rhombohedral modification of indium oxide. Therefore, in consequence of the thermal annealing, the initial cubic structure was partially transformed into a rhombohedral structure. The rhombohedral polymorphic modification of indium oxide is the so-called high pressure phase [9], *ie.*, this phase is metastable at normal pressures.

The nanostructural characterization of several In_2O_3 thin films has been carried out via TEM, HRTEM and

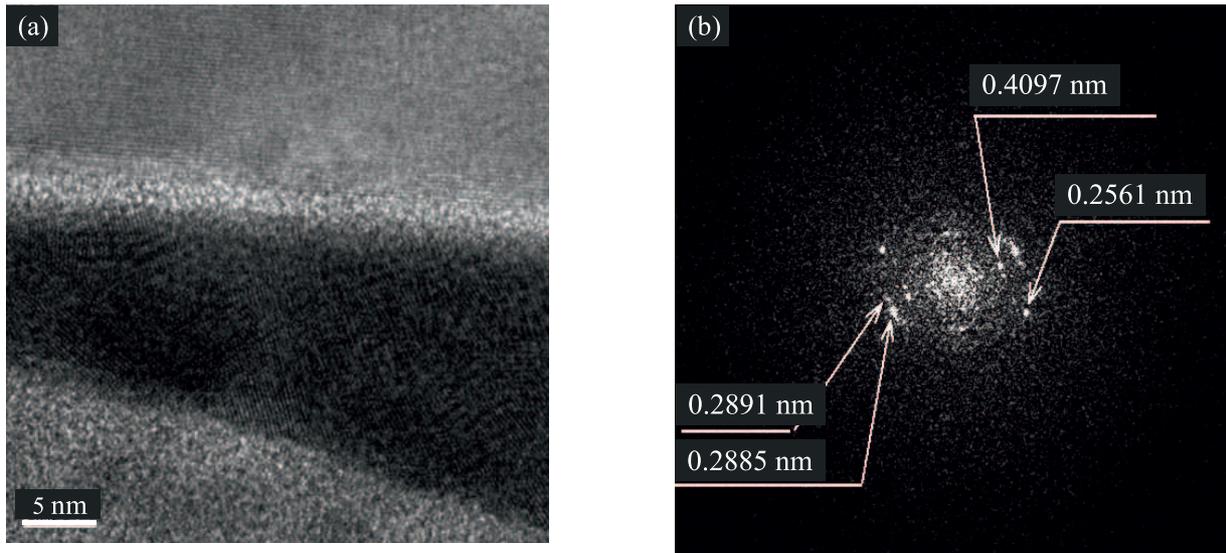


Fig. 4. HRTEM image (a)– and FFT pattern (b)– of In_2O_3 film prepared at a relative oxygen partial pressure of 20% and annealed at 400 °C in vacuum

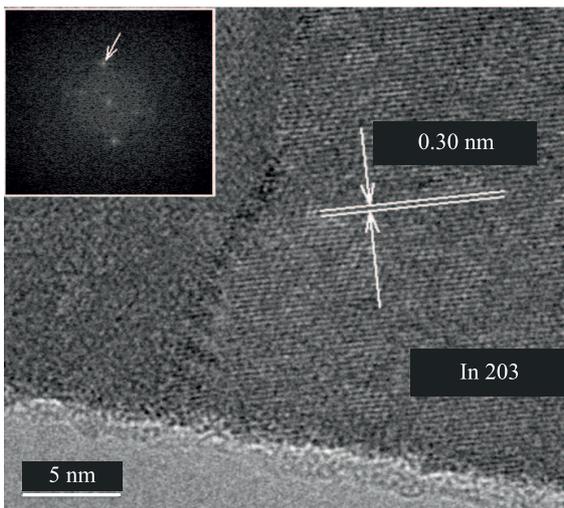


Fig. 5. HRTEM image of In_2O_3 film prepared at a relative oxygen partial pressure of 20% and annealed at 400 °C in Ar atmosphere

SAED. HRTEM observations (Fig. 3) of as-deposited In_2O_3 films confirmed that they were polycrystalline with fine-grained, however, they differ in grain size and thickness of the film. The size of the nanocrystals forming the layer ranges was about 20 nm for samples prepared at 15% oxygen content in sputtering gas while the size of crystallites decreased into the range under the 10 nm in the film deposited at 30% oxygen content (not shown herein). Confirmation of the presence of In_2O_3 in the deposited film has been obtained from SAED analyses. The FFT patterns of both as-deposited films consisted of spots creating the rings indicating a polycrystalline nature of film with high crystallinity of individual grains. By evaluation of FFT patterns (inset in Fig. 3) it was confirmed the presence of (bcc) structure of In_2O_3 .

The effect of post-deposition annealing was investigated for In_2O_3 films deposited at a relative oxygen partial pressure of 20%. In generally, during the annealing a coalescence of In_2O_3 nanocrystals has been observed. It was observed that in the case of annealing at 400 °C in vacuum (Fig. 4) the film maintained In_2O_3 (bcc) structure, however, measured interlayer distances 0.2885 nm and 0.2891 nm may be assigned both cubic and also rhombohedral In_2O_3 phases (222 diffraction of cubic In_2O_3 has 0.2921 nm, ICDD 6-0416, and 104 diffraction of rhombohedral In_2O_3 is 0.2883 nm, ICDD 21-0406).

In the case of annealing at 400 °C in Ar atmosphere uniform In_2O_3 film was observed. From measured interlayer distance of 0.3 nm obtained from HRTEM image (Fig. 5), it was not possible to distinguish between cubic and rhombohedral phases in this TEM cross section. We assume that although the majority of reflexes in FFT patterns obtained from various places of prepared film unequivocally confirm the presence of (bcc) In_2O_3 phase in the layer, the reflexes with the measured interlayer distances 0.3002 nm, 0.268, and 0.2986 nm can be assigned also to rhombohedral In_2O_3 phase that was confirmed using XRD measurements for samples after annealing. Therefore, additional detailed TEM and XRD observations will be necessary for confirmation the transition from the (bcc) polymorphic modification into the rhombohedral modification of indium oxide due to annealing.

4 CONCLUSIONS

Structural evolution of indium oxide thin films deposited at room temperature by reactive magnetron sputtering and annealing in a reducing atmosphere were investigated. Indium oxide films were polycrystalline with the size of nanocrystals ranging from a few nanometres

to 10 nm. Annealing in the reducing atmospheres shrinks the layer thickness and improves the crystallinity due to recrystallization and out-diffusion of incorporated gases as a consequence the residual strain in the layer, which causes a partial phase transition from the (bcc) polymorphic modification into the rhombohedral modification of indium oxide.

Acknowledgements

This work has been supported by the Scientific Grant Agency of the Ministry of Education of the Slovak Republic and the Slovak Academy of Sciences, No 1/0553/09, 1/0779/10, 1/0337/08, by the Slovak Research and Development Agency under the contract No VVCE-0049-07, PPP programme of DAAD No. D/08/07742 and Action R/S No. 63s7.

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Received 2 March 2010

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